



# 3.3V 600mA/250mA<sup>+</sup> Low Dropout Regulator

## Features

- Dropout voltage typically 0.65V/0.25V @  $I_o = 600\text{mA}/250\text{mA}^+$
- Output current in excess of 600mA/250mA<sup>+</sup>
- Output voltage accuracy  $\pm 2\%$
- Quiescent current, typically 0.3mA
- Internal short circuit current limit
- Internal over temperature protection

## General Description

The G910/G911 positive 3.3V voltage regulator features the ability to source 600mA/250mA<sup>+</sup> of output current with a dropout voltage of typically 0.65V/ 0.25V. A low quiescent current is provided. The typical quiescent current is 0.3mA.

[<sup>+</sup> For μTO92 & TO92 package]

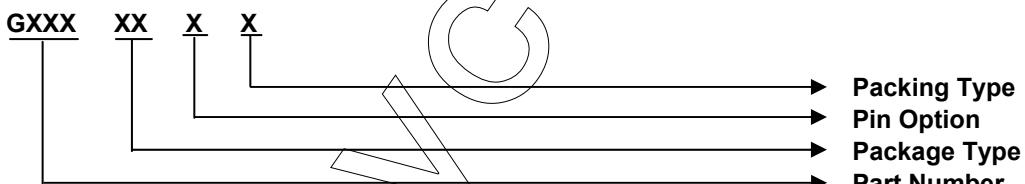
Familiar regulator features such as over temperature and over current protection circuits are provided to prevent it from being damaged by abnormal operating conditions.

## Ordering Information

ORDER NUMBER	TEMP. RANGE	PACKAGE	PIN OPTION		
			1	2	3
G910T21U	-40°C~85°C	SOT89	V <sub>OUT</sub>	GND	V <sub>IN</sub>
G911T24U	-40°C~85°C	SOT89	GND	V <sub>IN</sub>	V <sub>OUT</sub>
G911T24Uf	-40°C~85°C	SOT89 (Pb free)	GND	V <sub>IN</sub>	V <sub>OUT</sub>
G910T65U	-40°C~85°C	SOT223	V <sub>IN</sub>	GND	V <sub>OUT</sub>
G910TD1B	-40°C~85°C	TO92	V <sub>OUT</sub>	GND	V <sub>IN</sub>
G911TD4B	-40°C~85°C	TO92	GND	V <sub>IN</sub>	V <sub>OUT</sub>
G910T81B	-40°C~85°C	μTO92	V <sub>OUT</sub>	GND	V <sub>IN</sub>
G911T84B	-40°C~85°C	μTO92	GND	V <sub>IN</sub>	V <sub>OUT</sub>
G911T85B	-40°C~85°C	μTO92	V <sub>IN</sub>	GND	V <sub>OUT</sub>

\* For other package types, pin options and package, please contact us at sales@gmt.com.tw

## Order Number Identification



### PACKAGE TYPE

T2 : SOT89

T6 : SOT223

T8 : μTO92

TD : TO92

### PIN OPTION

1	2	3
1 : V <sub>OUT</sub>	GND	V <sub>IN</sub>
2 : V <sub>OUT</sub>	V <sub>IN</sub>	GND
3 : GND	V <sub>OUT</sub>	V <sub>IN</sub>
4 : GND	V <sub>IN</sub>	V <sub>OUT</sub>
5 : V <sub>IN</sub>	GND	V <sub>OUT</sub>
6 : V <sub>IN</sub>	V <sub>OUT</sub>	GND

### PACKING

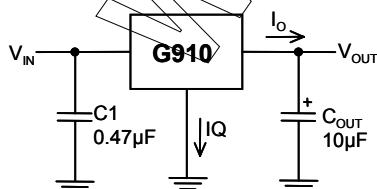
U & D : Tape & Reel Direction

T : Tube

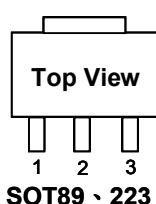
B : Bag

## Typical Application

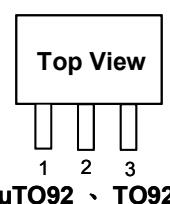
[Note 4]: Type of C<sub>OUT</sub>



## Package Type



Top View  
SOT89、223



Top View  
μTO92、TO92

**Absolute Maximum Ratings**

(Note 1)

Input Voltage.....	7V
Power Dissipation Internally Limited	(Note2)
Maximum Junction Temperature.....	150°C
Storage Temperature Range.....	-65°C ≤ T <sub>J</sub> ≤ +150°C
Reflow Temperature (soldering, 10sec).....	260°C
Continuous Power Dissipation (T <sub>A</sub> = +25°C)	
SOT89 <sup>(1)</sup> .....	0.5W
SOT223 <sup>(1)</sup> .....	0.8W
μTO92 & TO92 <sup>(1)</sup> .....	0.5W
Thermal Resistance Junction to Case	
SOT89.....	.55°C/W
SOT223.....	.25°C/W

Note <sup>(1)</sup>: See Recommended Minimum Footprint.**Operating Conditions**

(Note 1)

Input Voltage.....	4V ~ 6.5V
Temperature Range.....	-40°C ≤ T <sub>A</sub> ≤ 85°C

**Electrical Characteristics**V<sub>IN</sub> = 5V, I<sub>O</sub> = 600mA/250mA+, C<sub>IN</sub> = 10μF, C<sub>OUT</sub> = 10μF. All specifications apply for T<sub>A</sub> = T<sub>J</sub> = 25°C.[Note 3]

PARAMETER	CONDITION	MIN	TYP	MAX	UNIT
Output Voltage	10mA ≤ I <sub>O</sub> ≤ 600mA	3.234	3.3	3.366	V
	10mA ≤ I <sub>O</sub> ≤ 250mA <sup>+</sup>				
Line Regulation	4V ≤ V <sub>IN</sub> ≤ 6V, I <sub>O</sub> = 10mA	---	15	---	mV
Load Regulation	10mA ≤ I <sub>O</sub> ≤ 600mA	---	20	---	mV
	10mA ≤ I <sub>O</sub> ≤ 250mA <sup>+</sup>				
Quiescent Current	V <sub>IN</sub> = 5V	---	0.3	---	mA
Ripple Rejection	f <sub>r</sub> = 120 Hz, 1V <sub>P-P</sub> , I <sub>O</sub> = 100mA	---	47	---	dB
Dropout Voltage	I <sub>O</sub> = 600mA	---	0.65	---	V
	I <sub>O</sub> = 250mA <sup>+</sup>				
Output Current	Continuous Test T <sub>A</sub> = 25°C, T <sub>J</sub> < 125°C, V <sub>OUT</sub> within ±2% (Note 2)	V <sub>IN</sub> = 4.5V, mounted on SOT89 recommended minimum footprint V <sub>IN</sub> = 5.2V, μTO92 & TO92 package 0.53 inch leads soldered to PC Board	600	---	mA
Short Circuit Current		---	0.65	---	A
Current Limit			0.8	---	A
Over Temperature		---	145	---	°C

[<sup>+</sup> for μTO92 & TO92 Package]

**Note 1:** Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Conditions are conditions under which the device functions but the specifications might not be guaranteed. For guaranteed specifications and test conditions see the Electrical Characteristics.

**Note2:** The maximum power dissipation is a function of the maximum junction temperature, T<sub>Jmax</sub>; total thermal resistance, θ<sub>JA</sub>, and ambient temperature T<sub>A</sub>. The maximum allowable power dissipation at any ambient temperature is T<sub>Jmax</sub> - T<sub>A</sub> / θ<sub>JA</sub>. If this dissipation is exceeded, the die temperature will rise above 150°C and IC will go into thermal shutdown. For the G910 in SOT89 package & μTO92, TO92, θ<sub>JA</sub> is 250°C/W and in the SOT223 package is 156°C/W (See Recommended Minimum Footprint). The safe operation in SOT89, μTO92, TO92 & SOT223 package, it can see "Typical Performance Characteristics" (Safe Operating Area).

**Note3:** Low duty pulse techniques are used during test to maintain junction temperature as close to ambient as possible.

**Note4:** The type of output capacitor should be tantalum or aluminum.

**Definitions****Dropout Voltage**

The input/output voltage differential at which the regulator output no longer maintains regulation against further reductions in input voltage. Measured when the output drops 100mV below its nominal value, dropout voltage is affected by junction temperature, load current and minimum input supply requirements.

**Line Regulation**

The change in output voltage for a change in input voltage. The measurement is made under conditions of low dissipation or by using pulse techniques such that average chip temperature is not significantly affected.

**Load Regulation**

The change in output voltage for a change in load current at constant chip temperature. The measurement is made under conditions of low dissipation or by using pulse techniques such that average chip temperature is not significantly affected.

**Maximum Power Dissipation**

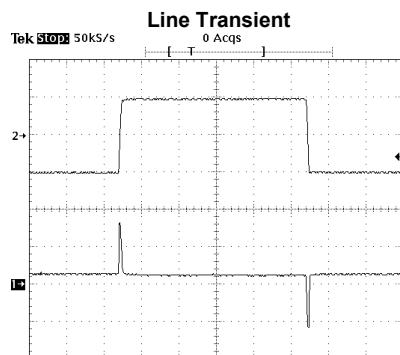
The maximum total device dissipation for which the regulator will operate within specifications.

**Quiescent Bias Current**

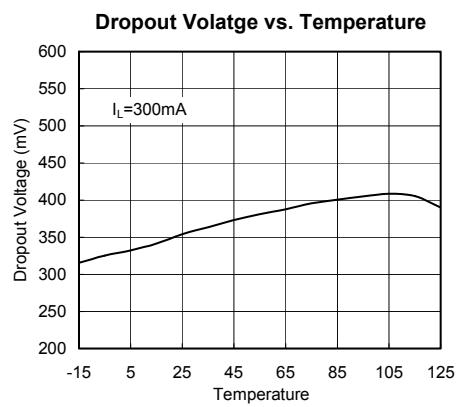
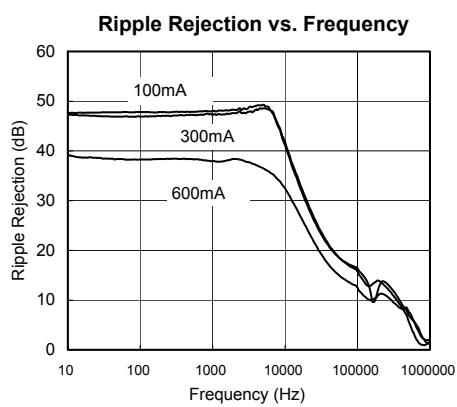
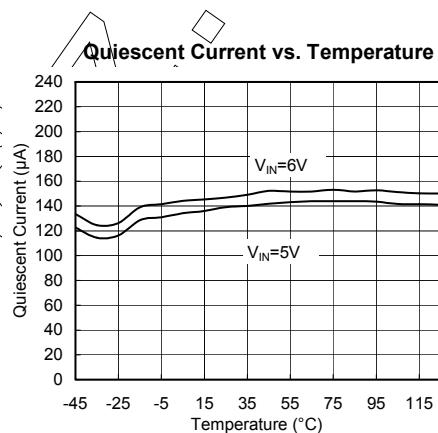
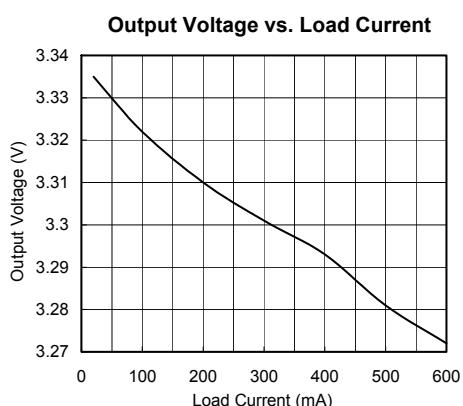
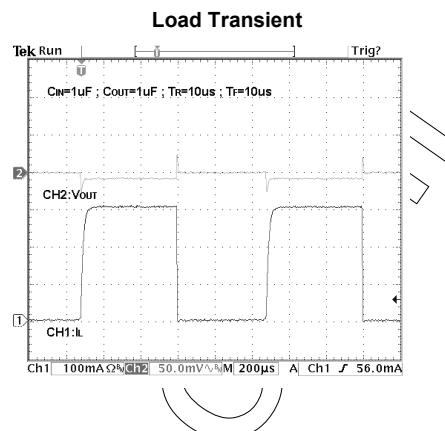
Current which is used to operate the regulator chip and is not delivered to the load.

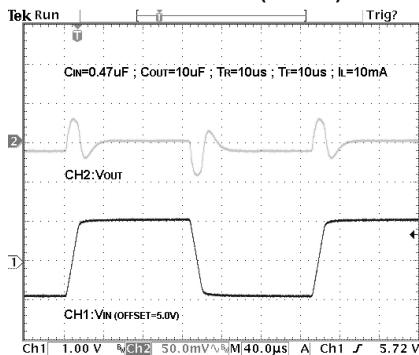
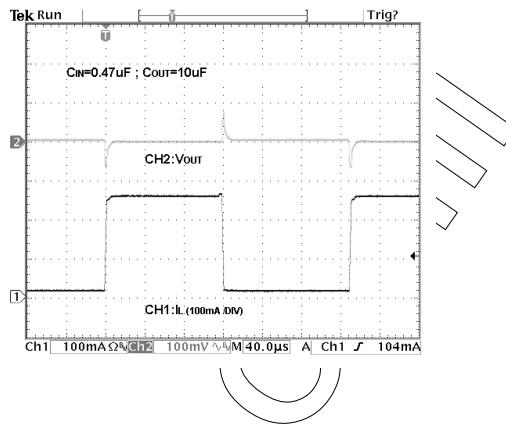
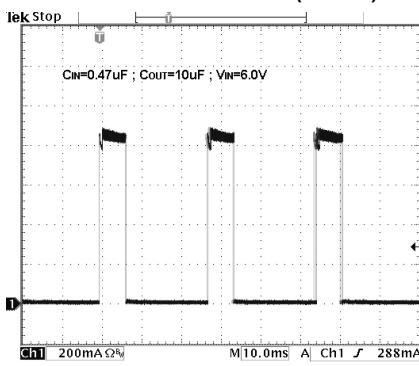
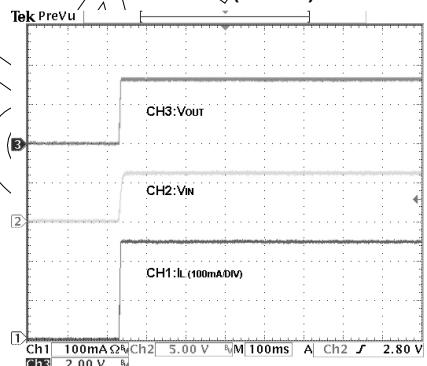
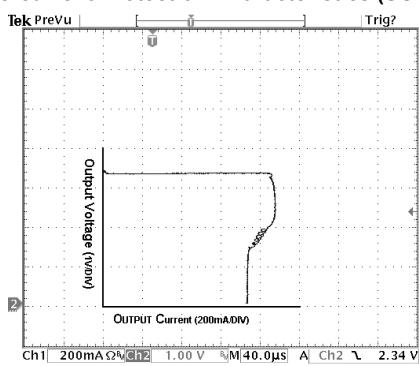
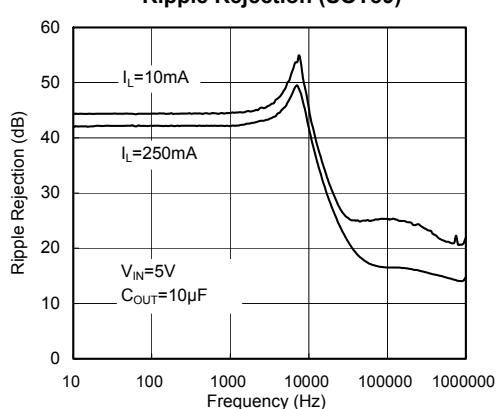
## Typical Performance Characteristics

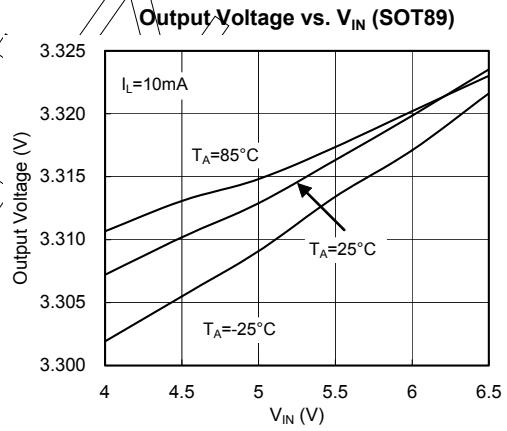
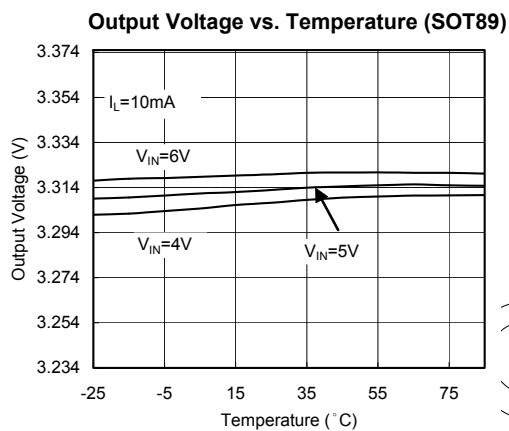
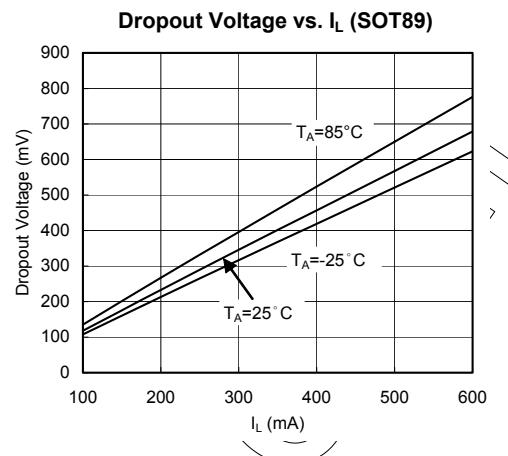
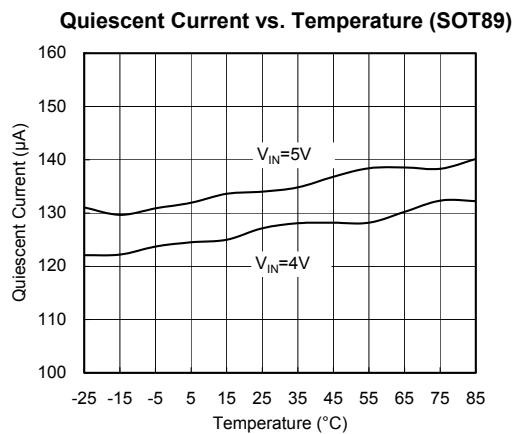
$V_{IN}=5V$ ,  $C_{IN}=1\mu F$ ,  $C_{OUT}=10\mu F$ ,  $T_A=25^\circ C$ , unless otherwise noted.)

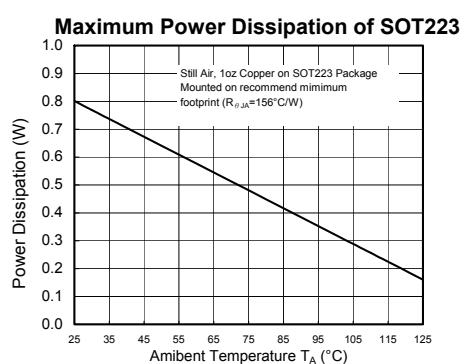
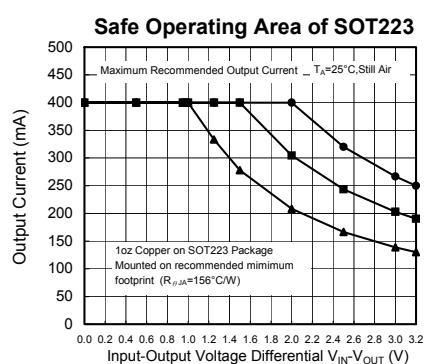
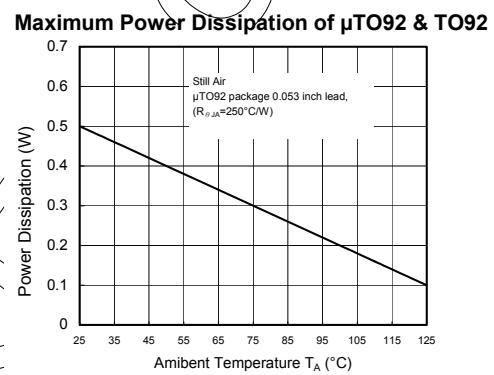
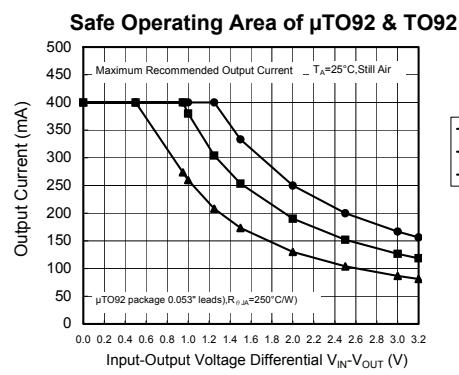
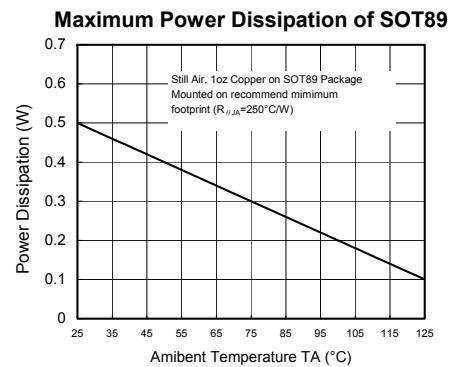
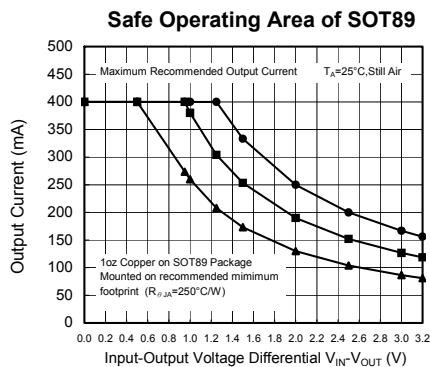
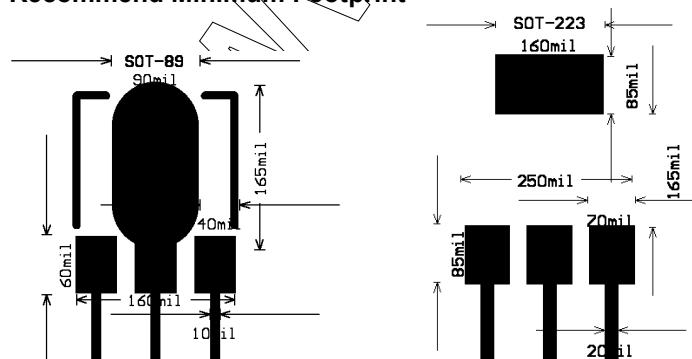


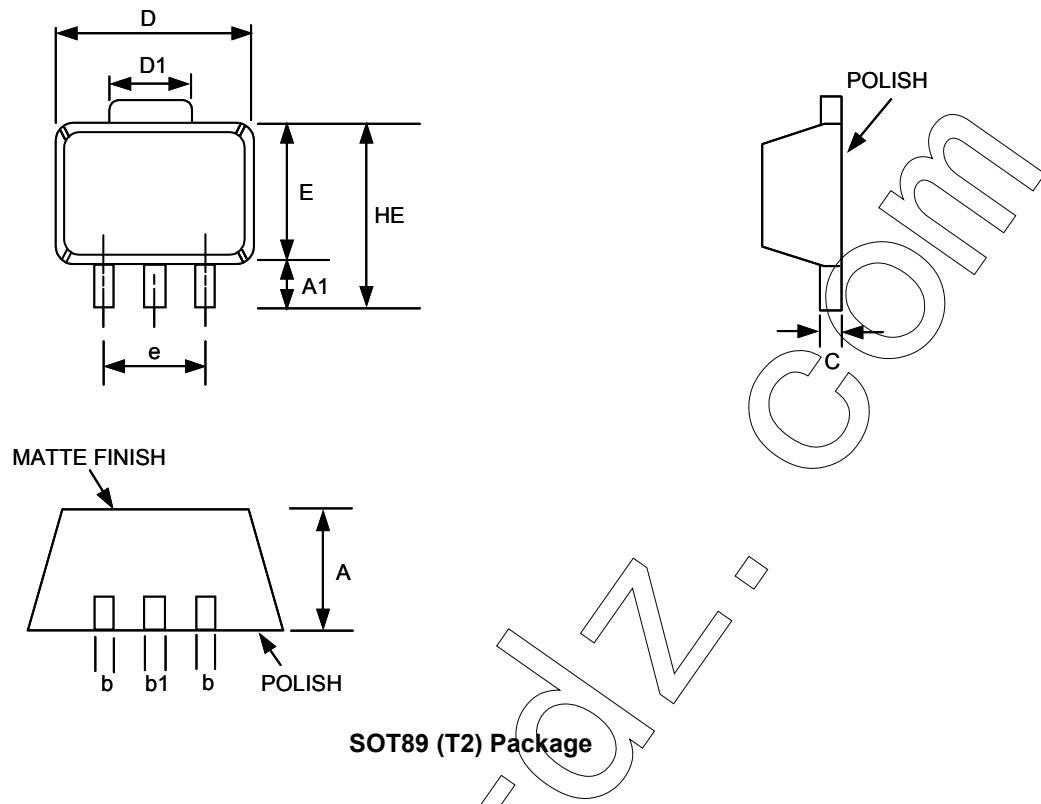
Ch1:  $V_{OUT}$  (offset=3.30V)  
 Ch2:  $V_{IN}$  (offset=5.0V)  
 $I_{OUT}=100mA$



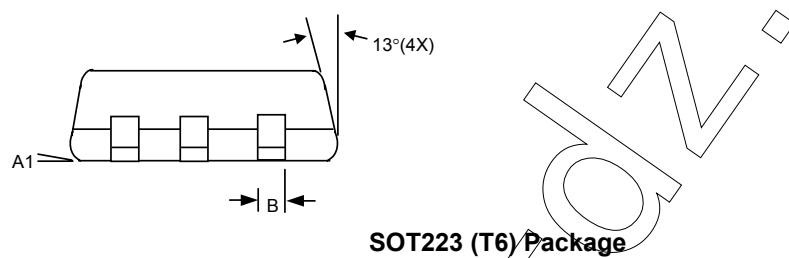
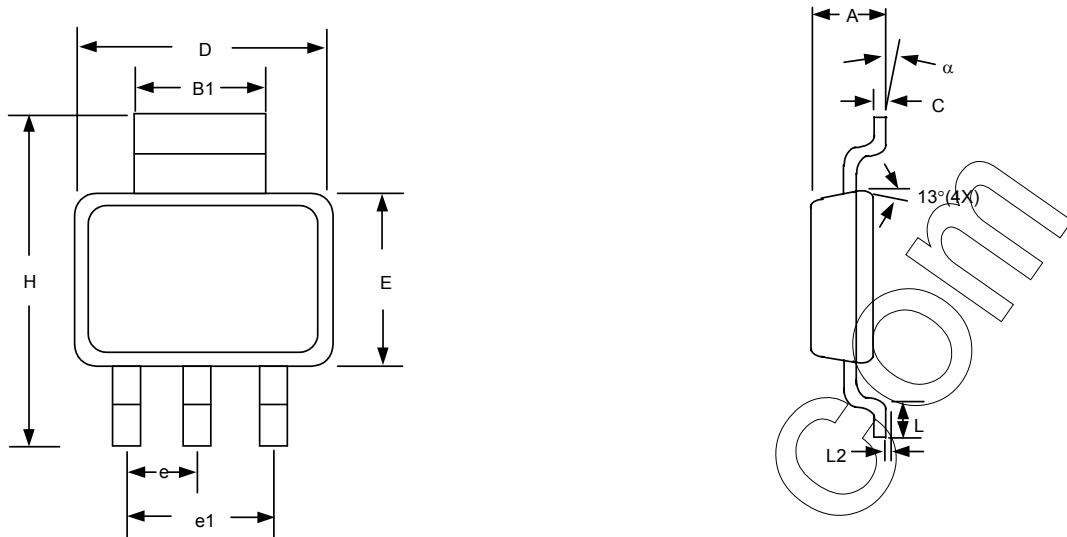
**Typical Performance Characteristics (continued)**
**Line Transient (SOT89)**

**Load Transient (SOT89)**

**Short Circuit Current (SOT89)**

**Start-UP (SOT89)**

**Overcurrent Protection Characteristics (SOT89)**

**Ripple Rejection (SOT89)**


**Typical Performance Characteristics (continued)**


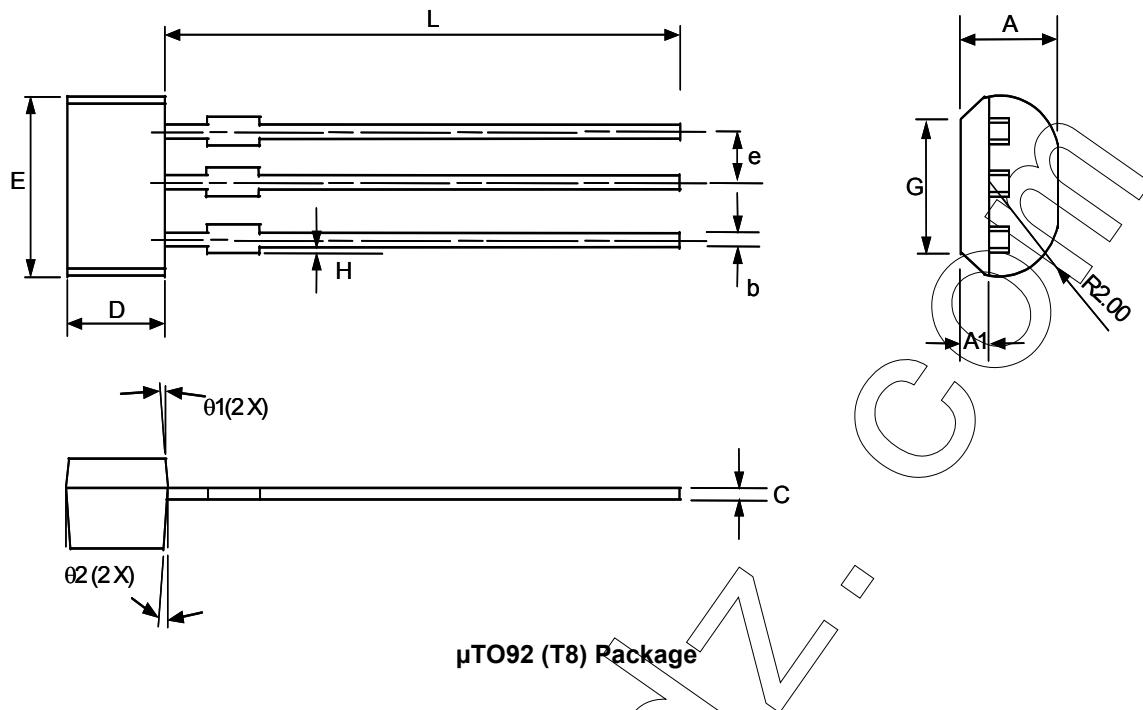
**Typical Performance Characteristics (continued)**

**Recommend Minimum Footprint**


**Package Information**


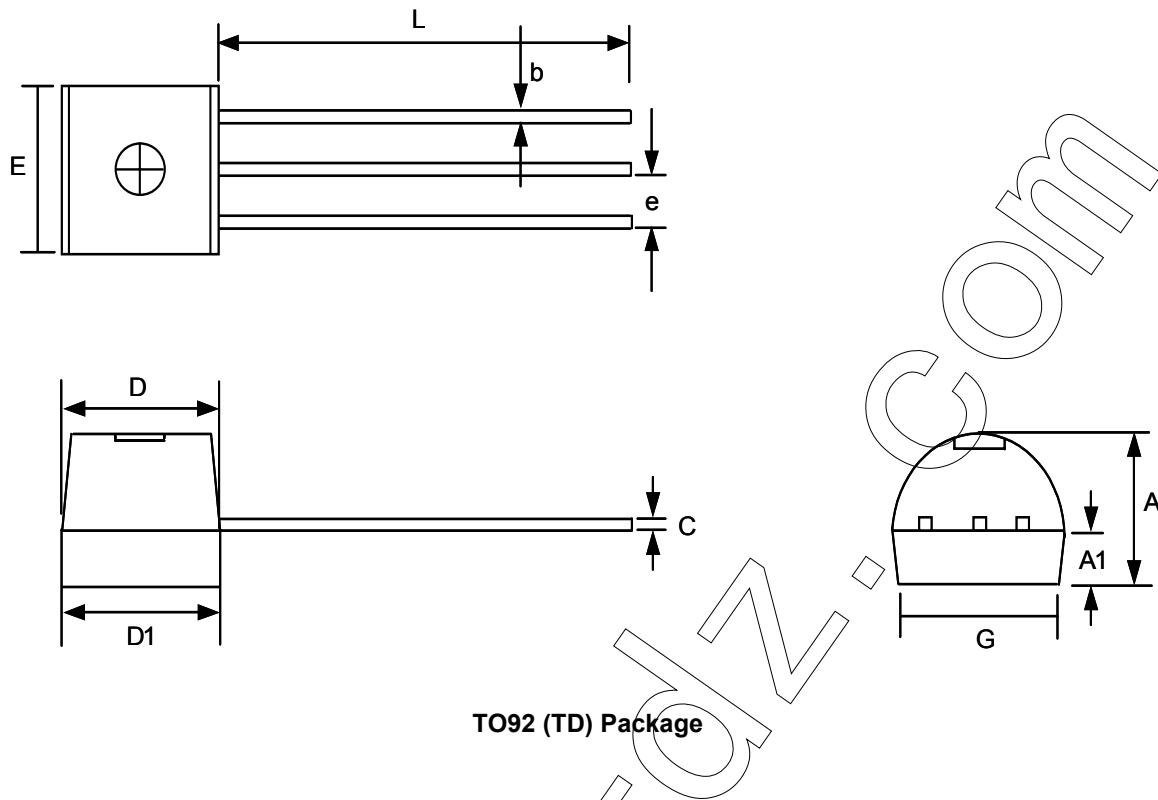
SYMBOL	DIMENSIONS IN MILLIMETER			DIMENSIONS IN INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.40	1.50	1.60	0.055	0.059	0.063
A1	0.80	1.04	-----	0.031	0.041	-----
b	0.36	0.42	0.48	0.014	0.016	0.048
b1	0.41	0.47	0.53	0.016	0.018	0.020
C	0.38	0.40	0.43	0.014	0.015	0.017
D	4.40	4.50	4.60	0.173	0.177	0.181
D1	1.40	1.60	1.75	0.055	0.062	0.069
HE	-----	-----	4.25	-----	-----	0.167
E	2.40	2.50	2.60	0.094	0.098	0.102
e	2.90	3.00	3.10	0.114	0.118	0.122



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	1.55	1.80	0.061	0.071
A1	0.02	0.12	0.0008	0.0047
B	0.60	0.80	0.024	0.031
B1	2.90	3.10	0.114	0.122
C	0.24	0.32	0.009	0.013
D	6.30	6.70	0.248	0.264
E	3.30	3.70	0.130	0.146
e	2.30 BSC		0.090 BSC	
e1	4.60 BSC		0.181 BSC	
H	6.70	7.30	0.264	0.287
L	0.90 MIN		0.036 MIN	
L2	0.06 BSC		0.0024 BSC	
alpha	0°	10°	0°	10°

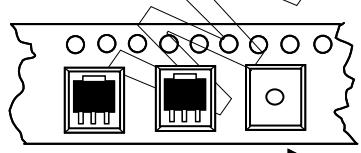


SYMBOL	DIMENSIONS IN MILLIMETER			DIMENSIONS IN INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	2.40	2.50	2.60	0.094	0.098	0.102
A1	0.70	0.80	0.90	0.028	0.032	0.036
b	0.35	0.45	0.55	0.014	0.018	0.022
C	----	0.40	----	----	0.016	----
D	2.80	3.00	3.20	0.110	0.118	0.126
E	3.80	4.00	4.20	0.149	0.157	0.165
e	----	1.27	----	----	0.050	----
F	1.91	2.11	2.31	0.075	0.083	0.091
G	3.35	3.55	3.75	0.132	0.140	0.148
H	0.00	----	0.15	0.000	----	0.006
L	13.80	14.00	14.20	0.543	0.551	0.559
$\theta_1$	----	2°	----	----	2°	----
$\theta_2$	----	5°	----	----	5°	----



SYMBOL	MILLIMETER		INCH	
	MIN	MAX	MIN	MAX
A	3.35	3.86	0.132	0.152
A1	1.0414	1.55	0.041	0.061
b	0.254	0.508	0.010	0.020
E	4.34	4.85	0.171	0.191
C	0.254	0.508	0.010	0.020
L	14.53	15.04	0.572	0.592
e	1.143	1.397	0.045	0.055
G	3.683	4.191	0.145	0.165
D	4.29	4.80	0.169	0.189
D1	4.34	4.85	0.171	0.191

### Package Orientation



**Feed Direction**  
**SOT89、223 Package Orientation**

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